INFORMATION DISCLOSURE CITATION	Applicant: Simon FENNEY, et al
	Ser.No. : 10/611 719 Filed : July 1, 2003
	Conf. No.: 6086 Atty.Ref.: R&G 359
	Group : 2673

DEC 0 8 2003
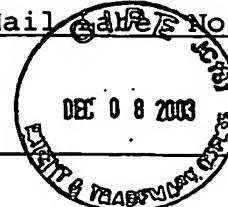
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Examiner Initial*		Document Number	Date	Name	Class	Sub Class	Filing Date
A.C.	AA	5 949 424	Sep 1999	Cabral, et al	—	—	
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A.C.	AL	WO 99/09523	Feb 1999	WIPO	—	—		
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EXAMINER Auto Cole	DATE CONSIDERED 3/8/04

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